Field Stop Trench IGBT With Soft Fast Recovery Diode and V_{CESAT}, V_{TH} Binning

650 V, 160 A

AFGY160T65SPD-B4

Features

- AEC-Q101 Qualified and PPAP Capable
- Very Low Saturation Voltage: V_{CE(sat)} = 1.6 V (Typ.) @ I_C = 160 A
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-Efficient
- Tight Parameter Distribution
- High Input Impedance
- 100% of the Parts are Dynamically Tested
- Short Circuit Ruggedness > 6 μs @ 25°C
- Copacked with Soft, Fast Recovery Extremefast Diode
- This Device is Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Benefits

- Very Low Conduction and Switching Losses for a High Efficiency Operation in Various Applications
- Rugged Transient Reliability
- Outstanding Parallel Operation Performance with Balance Current Sharing
- Low EMI

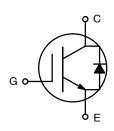
Applications

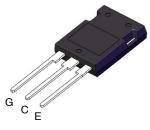
- Traction Inverter for HEV/EV
- Auxiliary DC/AC Converter
- Motor Drives
- Other Power-Train Applications Requiring High Power Switch



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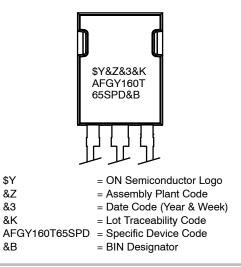
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TO-247-3LD CASE 340CU

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Ratings	Unit
V _{CES}	Collector to Emitter Voltage	650	V
V_{GES}	Gate to Emitter Voltage	±20	V
	Transient Gate to Emitter Voltage	±30	V
Ι _C	Collector Current @ T _C = 25°C (Note 1)	240	А
	Collector Current @ T _C = 100°C	220	А
I _{Nominal}	Nominal Current	160	А
I _{CM}	Pulsed Collector Current	480	А
I _{FM}	Diode Forward Current @ $T_C = 25^{\circ}C$ (Note 1)	240	А
	Diode Forward Current @ T _C = 100°C	188	А
PD	Maximum Power Dissipation @ $T_C = 25^{\circ}C$	882	W
	Maximum Power Dissipation @ $T_C = 100^{\circ}C$	441	W
SCWT	Short Circuit Withstand Time @ $T_C = 25^{\circ}C$	6	μs
$\Delta V / \Delta t$	Voltage Transient Ruggedness (Note 2)	10	V/ns
TJ	Operating Junction Temperature	–55 to +175	°C
T _{stg}	Storage Temperature Range	–55 to +175	°C
ΤL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Limited to bondwire. 2. $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_{CE} = 480 \text{ A}, Inductive load.}$

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.17	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	0.32	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Bin Designator	Packing Type	Qty per Tube/Reel*
AFGY160T65SPDA	AFGY160T65SPD-B4	А	Tube	30
AFGY160T65SPDB	AFGY160T65SPD-B4	В	Tube	30
AFGY160T65SPDC	AFGY160T65SPD-B4	С	Tube	30
AFGY160T65SPDD	AFGY160T65SPD-B4	D	Tube	30

*Generally all tubes in one box will belong to the same bin. In rare and unusual cases there may be tubes from more than one bin inside one box. Such mixing would not be considered a quality excursion. The primary container quantity (MPQ) for these binning products is 30 units and therefore partial box shipment can be expected.

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS							
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_{C} = 1 mA	650	-	-	V	
$\Delta BV_{CES}/\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	-	0.6	-	V/°C	
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	40	μΑ	
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±250	nA	

ON CHARACTERISTICS

V _{GE(th)A}	G-E Threshold (Bin A)	Ic = 160 mA; $V_{CE} = V_{GE}$	5.15	5.5	6.3	V
V _{CE(sat)A}	Collector to Emitter Saturation Voltage (Bin A)	lc = 160 A; V _{GE} = 15 V	1.5	1.6	1.67	V
$V_{GE(th)B}$	G-E Threshold (Bin B)	Ic = 160 mA; $V_{CE} = V_{GE}$	5.15	5.5	6.3	V
V _{CE(sat)B}	Collector to Emitter Saturation Voltage (Bin B)	lc = 160 A; V _{GE} = 15 V	1.57	1.64	2.05	V
V _{GE(th)C}	G-E Threshold (Bin C)	lc = 160 mA; $V_{CE} = V_{GE}$	4.3	5.3	5.65	V
V _{CE(sat)C}	Collector to Emitter Saturation Voltage (Bin C)	lc = 160 A; V _{GE} = 15 V	1.5	1.6	1.67	V
V _{GE(th)D}	G-E Threshold (Bin D)	$Ic = 160 \text{ mA}; V_{CE} = V_{GE}$	4.3	5.3	5.65	V
V _{CE(sat)D}	Collector to Emitter Saturation Voltage (Bin D)	lc = 160 A; V _{GE} = 15 V	1.57	1.64	2.05	V
V _{GE(th)}	G-E Threshold	$Ic = 160 \text{ mA}; V_{CE} = V_{GE}$	4.3	5.3	6.3	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	lc = 160 A; V _{GE} = 15 V	-	1.6	2.05	V
		lc = 160 A; V_{GE} = 15 V; T _J = 175°C	-	2.15	-	V

DYNAMIC CHARACTERISTICS

C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	6710	-	pF
C _{oes}	Output Capacitance		-	450	-	pF
C _{res}	Reverse Transfer Capacitance		-	55	-	pF
R _G	Internal Gate Resistance	f = 1 MHz	-	3	-	Ω

SWITCHING CHARACTERISTICS

T _{d(on)}	Turn-On Delay Time	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 400 \text{ V}, \ I_C = 160 \text{ A}, \\ R_G = 5 \ \Omega, \ V_{GE} = 15 \text{ V}, \\ Inductive \ Load, \ T_J = 25^\circ C \end{array}$	-	53	-	ns
Tr	Rise Time		-	197	-	ns
T _{d(off)}	Turn-Off Delay Time		-	98	-	ns
T _f	Fall Time		-	141	-	ns
E _{on}	Turn-On Switching Loss		-	12.4	-	mJ
E _{off}	Turn-Off Switching Loss		-	5.7	-	mJ
E _{ts}	Total Switching Loss		-	18.1	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 160 \text{ A},$	-	52	-	ns
T _r	Rise Time	$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_J = 175^{\circ}C$	-	236	-	ns
T _{d(off)}	Turn-Off Delay Time		-	104	-	ns
T _f	Fall Time		-	204	-	ns
E _{on}	Turn-On Switching Loss	1	-	21	-	mJ
E _{off}	Turn-Off Switching Loss]	-	8.5	-	mJ
E _{ts}	Total Switching Loss]	-	29.5	-	mJ

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
SWITCHING CHARACTERISTICS						
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 160 A, V _{GE} = 15 V	-	163	245	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	50	-	nC
Q _{gc}	Gate to Collector Charge		-	49	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{FM}	Diode Forward Voltage	I _F = 160 A	$T_J = 25^{\circ}C$	-	1.4	1.7	V
			T _J = 175°C	-	1.35	-	
E _{rec}	Reverse Recovery Energy	$V_{CE} = 400 \text{ V}, I_F = 160 \text{ A},$	$T_J = 25^{\circ}C$	-	598	-	μJ
		$\Delta I_{F}/\Delta t = 1000 \text{ A}/\mu \text{s}$	T _J = 175°C	-	4000	-	
T _{rr}	Diode Reverse Recovery		$T_J = 25^{\circ}C$	-	132	-	ns
	Time		T _J = 175°C	-	245	-	
Q _{rr}	Diode Reverse Recovery		$T_J = 25^{\circ}C$	-	3.3	-	μC
	Charge		T _J = 175°C	-	12.5	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

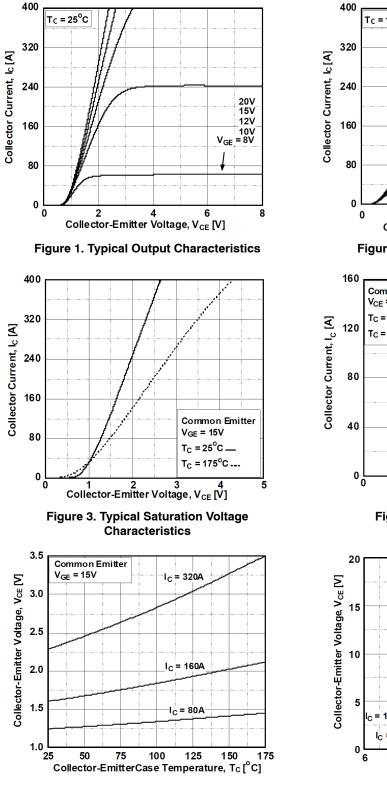


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

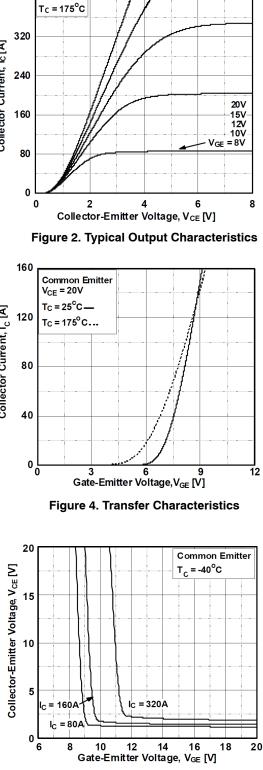
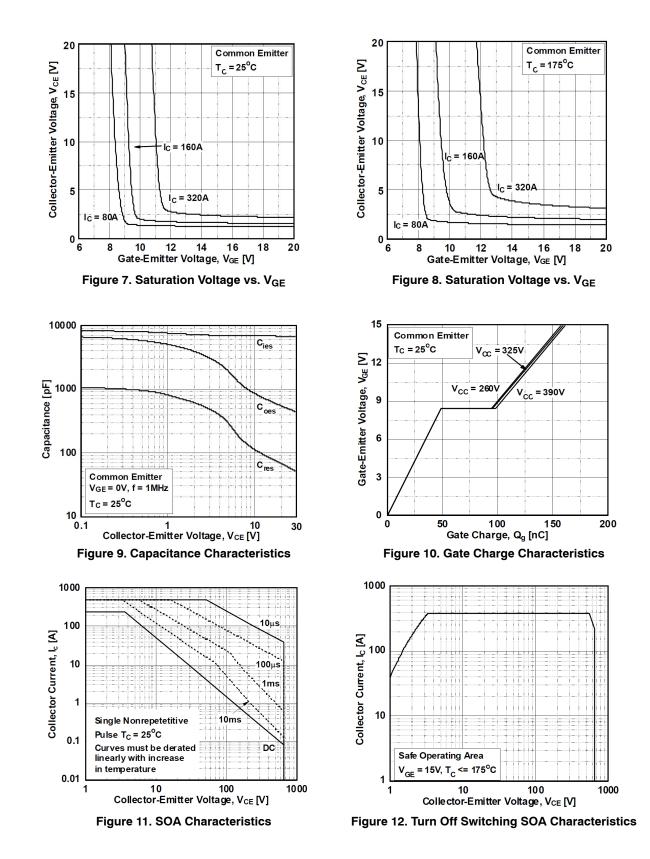


Figure 6. Saturation Voltage vs. V_{GE}



TYPICAL PERFORMANCE CHARACTERISTICS

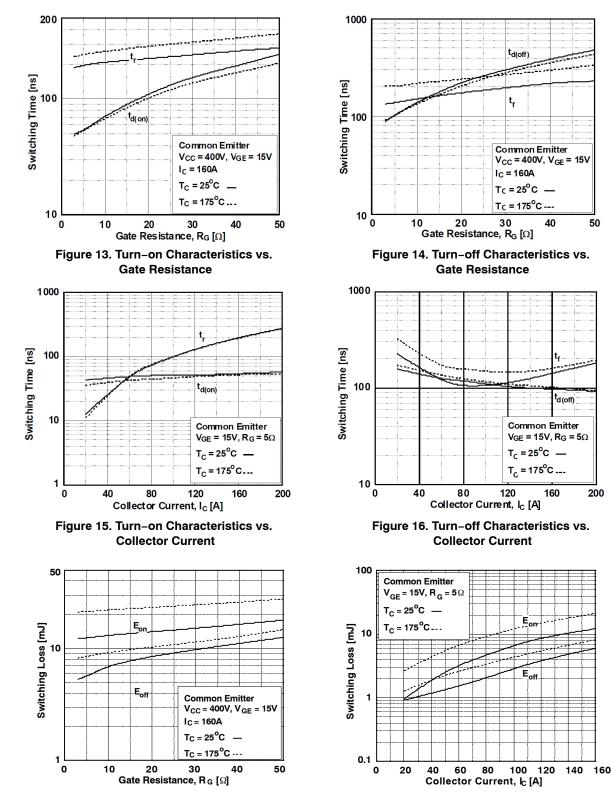
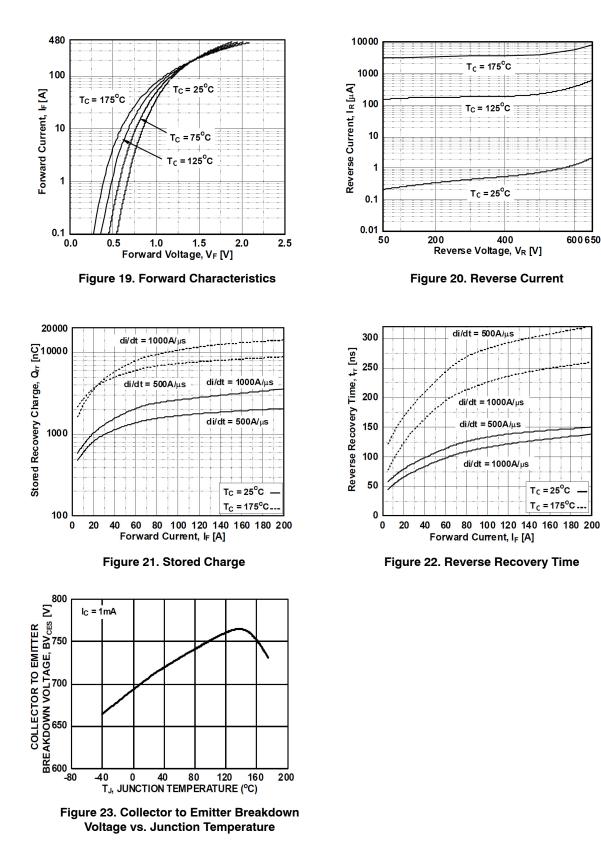


Figure 17. Switching Loss vs. Gate Resistance

Figure 18. Switching Loss vs. Collector Current

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600650



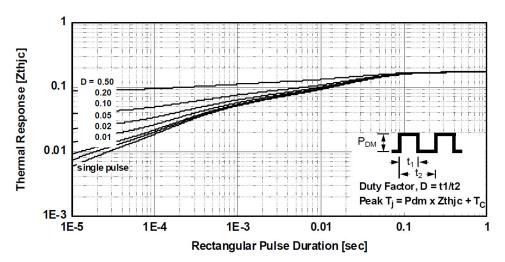


Figure 24. Transient Thermal Impedance of IGBT

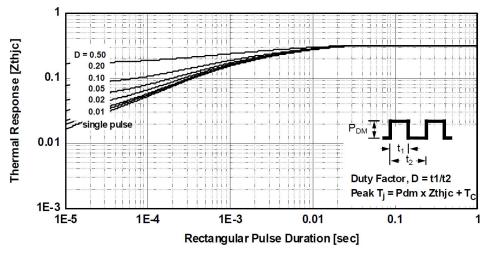
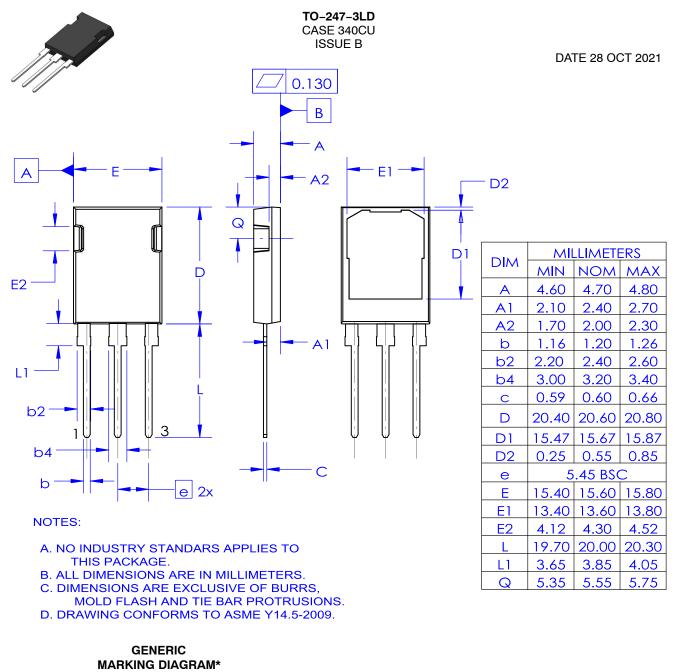


Figure 25. Transient Thermal Impedance of Diode

Onsem



С AYWWZZ XXXXXXXXX

XXXXXXXXXX

XXXX = Specific Device Code = Assembly Site Code = Year ww = Work Week

Α

Υ

ZZ

= Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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